### 1. General description

The NX5DV715 is a dual supply 1-to-2 VGA switch. It integrates high-bandwidth SPDT switches with level-translating buffers and level translating switches to provide switching of input RGB, H-Sync, V-Sync and DDC signals to either of two output channels.

The NX5DV715 is characterized for operation from -40 °C to +85 °C.

### 2. Features and benefits

- RGB switches:
  - Low ON resistance (4 Ω typical)
  - Low ON capacitance (12 pF typical)
  - Low output skew (50 ps)
- Low power consumption (< 2 μA)</p>
- Level translation of sync and DDC signals
- Over-voltage tolerant inputs
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 4 kV
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101D exceeds 1000 V
  - IEC61000-4-2 contact discharge exceeds 4 kV for I/Os
- Specified from –40 °C to +85 °C

### 3. Applications

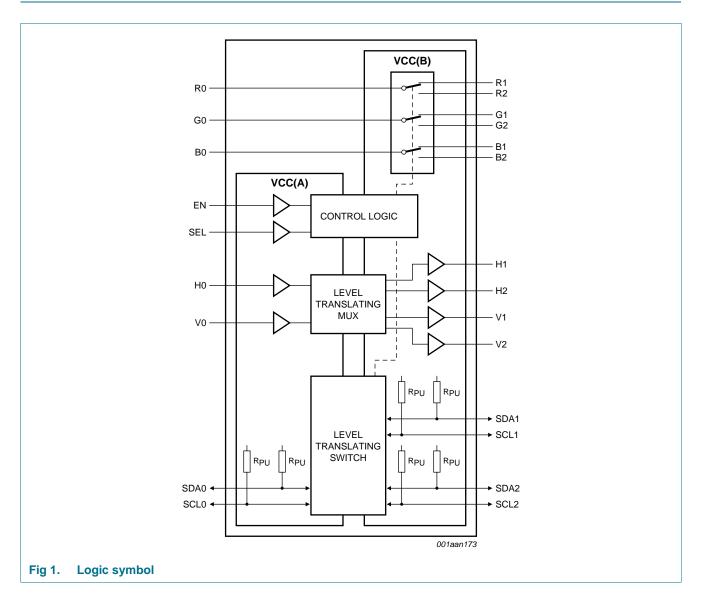
- Notebook Computers
- Docking stations
- Digital projectors
- Computer monitors
- Servers
- Storage



#### **Ordering information** 4.

Table 1. Ordering information						
Type number Package						
	Temperature range	Name	Description	Version		
NX5DV715HF	–40 °C to +85 °C	HWQFN32	plastic thermal enhanced very very thin quad flat package; no leads; 32 terminals; body $3 \times 6 \times 0.75$ mm	SOT1180-1		

#### **Functional diagram** 5.



NX5DV715 Product data sheet

Dual supply 1-of-2 VGA switch

### 6. Pinning information

### 6.1 Pinning

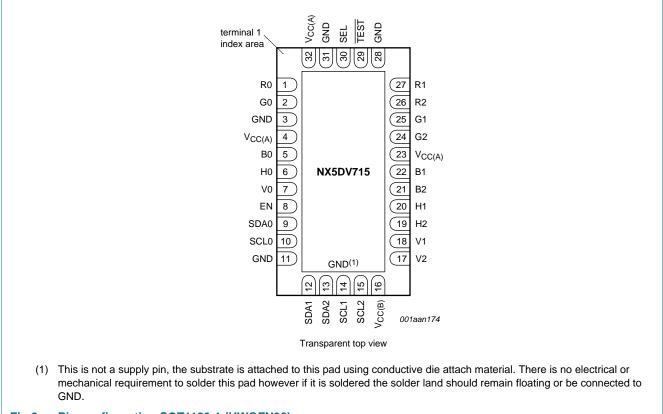


Fig 2. Pin configuration SOT1180-1 (HWQFN32)

### 6.2 Pin description

#### Table 2. **Pin description** Symbol Description Pin R0, G0, B0 1, 2, 5 RGB input or output GND 3, 11, 28, 31 ground (0 V) 4, 23, 32 supply voltage A V<sub>CC(A)</sub> H0 6 horizontal sync input V0 7 vertical sync input ΕN 8 enable input (active HIGH) 9 SDA0 SDA0 input or output SCL0 10 SCL0 input or output SDA1, SDA2 12, 13 SDA input or output SCL1, SCL2 14, 15 SCL input or output 16 supply voltage B V<sub>CC(B)</sub> V1, V2 18, 17 vertical sync output H1, H2 20, 19 horizontal sync output

Table 2.         Pin descriptioncom	able 2. Pin descriptioncontinued					
Symbol	Pin	Description				
R1, G1, B1, R2, G2, B2	27, 25, 22, 26, 24, 21	RGB input or output				
TEST <sup>[1]</sup>	29	test pin (active LOW)				
SEL	30	select input				

[1] Test pin used to enable test mode. For normal usage, this pin must be connected to V<sub>CC(A)</sub>.

### 7. Functional description

The NX5DV715 integrates high-bandwidth SPDT switches, level-translating buffers and level translating SPDT switches to provide a complete solution for 1-to-2 switching of VGA signals. An enable input (EN) is used to enable or disable the device and a select input (SEL) is used to determine which output is selected. When EN = LOW the device is disabled; all switches will be off, pull-up resistors will be disabled and H1, V1, H2, V2 will be forced LOW.

#### 7.1 RGB switches

The NX5DV715 provides three identical single pole double throw high-bandwidth switches to route standard VGA RGB signals (see <u>Table 3</u>).

#### Table 3.Function table RGB

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	R0 to R1; G0 to G1; B0 to B1
Н	Н	R0 to R2; G0 to G2; B0 to B2
L	Х	switches Rn, Gn, Bn off

### 7.2 H-Sync/V-Sync level translator

The horizontal and vertical synchronization buffers have inputs (H0, V0) referenced to  $V_{CC(A)}$  and outputs (H1, V1 and H2, V2) that are referenced to  $V_{CC(B)}$ . This allows level translation of synchronization signals from as low as 2.0 V up to 5.5 V and supports low-voltage CMOS or TTL-compatible graphics controllers meeting the VESA specification for output drive of  $\pm 8$  mA. The EN input also controls the level shifter (See Table 4).

#### Table 4.Function table HV

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	H1 = H0; V1 = V0; H2, V2 = L
Н	Н	H2 = H0; V2 = V0; H1, V1 = L
L	Х	L

### 7.3 Display-Data Channel Multiplexer

The NX5DV715 provides two identical SPDT active-level translating switches to route DDC signals (See <u>Table 5</u>). The switch outputs are limited to a diode drop less than the voltage applied on V<sub>CC(A)</sub>. To provide VESA I<sup>2</sup>C-compatible signals 3.3 V should be applied to V<sub>CC(A)</sub>. If voltage translation is not required V<sub>CC(A)</sub> should be connected to V<sub>CC(B)</sub>. Switch terminals include integrated pull-up resistors; inputs (SDA0, SCL0) are pulled up to V<sub>CC(A)</sub>, outputs (SDA1, SCL1 and SDA2, SCL2) are pulled up to V<sub>CC(B)</sub>. When the NX5DV715 is disabled (EN = LOW), the pull-up resistors are also disabled.

Table 5.Function table DDC

H = HIGH voltage level; $L = LOW$	voltage level; X = Don't care.
-----------------------------------	--------------------------------

Input		Switch
EN	SEL	
Н	L	SDA0 to SDA1, SCL0 to SCL1
Н	Н	SDA0 to SDA2, SCL0 to SCL2
L	Х	switches SDAn, SCLn off

### 8. Limiting values

#### Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		<b>3 3 1 1 1 1 1 1 1 1 1 1</b>		10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		-0.5	+6	V
V <sub>CC(B)</sub>	supply voltage B		-0.5	+6	V
VI	input voltage		<u>[1]</u> –0.5	+6	V
V <sub>SW</sub>	switch voltage		<u>[1]</u> –0.5	+6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	-50	-	mA
I <sub>SK</sub>	switch clamping current	V <sub>I</sub> < -0.5 V	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
lo	output current	$V_{O} = 0 V$ to $V_{CC(B)}$	-	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>	-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
I <sub>SW</sub>	switch current	$V_{SW} > -0.5$ V or $V_{SW} < 6$ V; source or sink current	-	±30	mA
		$V_{SW}$ > -0.5 V or $V_{SW}$ < 6 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±90	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	[2] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] For HWQFN32 package: above 137 °C the value of P<sub>tot</sub> derates linearly with 20.5 mW/K.

## 9. Recommended operating conditions

Recommended operating conditions					
Parameter	Conditions	Min	Тур	Max	Unit
supply voltage A		2	3.3	5.5	V
supply voltage B		4.5	5.0	5.5	V
ambient temperature	operating in free-air	-40	+25	+85	°C
input transition rise and fall rate	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	<u>[1]</u> _	20	-	ns/V
	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	<u>[1]</u> _	10	-	ns/V
	$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	<u>[1]</u> _	5	-	ns/V
	Parameter       supply voltage A       supply voltage B       ambient temperature	supply voltage Asupply voltage Bambient temperatureinput transition rise and fall rate $V_{CC(A)} = 2.3 V \text{ to } 2.7 V$ $V_{CC(A)} = 3 V \text{ to } 3.6 V$	ParameterConditionsMinsupply voltage A2supply voltage B4.5ambient temperatureoperating in free-air-40input transition rise and fall rate $V_{CC(A)} = 2.3 \vee to 2.7 \vee$ [1] $V_{CC(A)} = 3 \vee to 3.6 \vee$ [1]-	ParameterConditionsMinTypsupply voltage A23.3supply voltage B4.55.0ambient temperatureoperating in free-air-40+25input transition rise and fall rate $V_{CC(A)} = 2.3 \vee to 2.7 \vee$ [1]-20 $V_{CC(A)} = 3 \vee to 3.6 \vee$ [1]-10	ParameterConditionsMinTypMaxsupply voltage A23.35.5supply voltage B4.55.05.5ambient temperatureoperating in free-air-40+25+85input transition rise and fall rate $V_{CC(A)} = 2.3 V \text{ to } 2.7 V$ $\begin{bmatrix} 11 \\ 11 \\ -1 \end{bmatrix}$ 20- $V_{CC(A)} = 3 V \text{ to } 3.6 V$ $\begin{bmatrix} 11 \\ 11 \\ -1 \end{bmatrix}$ 10-

[1] Applies to control signal levels.

## **10. Static characteristics**

#### Table 8. Static characteristics

 $V_{CC(B)}$  = 4.5 V to 5.5 V;  $V_{CC(A)}$  = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Tamb	, = −40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
General						
I <sub>CC(A)</sub>	supply current A	$V_{CC(A)} = 3.3 \text{ V}; \text{ EN} = V_{CC(A)} \text{ or GND};$ for H1, H2, V1, V2: I <sub>0</sub> = 0 A; SCLn, SDAn unconnected	-	-	2.0	μA
I <sub>CC(B)</sub>	supply current B	$V_{CC(B)} = 5.0 \text{ V}; \text{ EN} = V_{CC(A)} \text{ or GND};$ for H1, H2, V1, V2: I <sub>O</sub> = 0 A; SCLn, SDAn unconnected	-	-	2.0	μA
HV buffe	er					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$	-	-	0.8	V
V <sub>H</sub>	hysteresis voltage		-	50	-	mV
I <sub>I</sub>	input leakage current	$V_{CC(B)} = V_{CC(A)} = 5.5 V;$ $V_I = GND to V_{CC(A)}$	-	-	±1	μA
V <sub>OH</sub>	HIGH-level output voltage	$I_{O} = -8 \text{ mA}$	V <sub>CC(B)</sub> 0.5		-	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>O</sub> = 8 mA	-	-	0.5	V
I <sub>OFF</sub>	power-off leakage current		-	-	±1	μA
RGB swi	itches					
$I_{S(OFF)}$	OFF-state leakage current		-	-	±1	μA
I <sub>S(ON)</sub>	ON-state leakage current		-	-	±1	μA
R <sub>ON</sub>	ON resistance	$V_I = 0.7 \text{ V}; I_{SW} = -10 \text{ mA}; \text{ See } \frac{\text{Figure 5}}{\text{Figure 6}}$ and $\frac{\text{Figure 6}}{\text{Figure 6}}$	<u>[4]</u> _	4	-	Ω

Dual supply 1-of-2 VGA switch

Symbol	Parameter	Conditions		$T_{amb}$ = -40 °C to +85 °C			Unit
			-		Typ[1]	/p <sup>[1]</sup> Max	
$\Delta R_{ON}$	ON resistance mismatch between channels	$V_{\rm I}$ = GND to 0.7 V; $I_{\rm SW}$ = –10 mA	[2]	-	0.5	-	Ω
R <sub>ON(flat)</sub>	ON resistance (flatness)	$V_{\rm I}=GND$ to 0.7 V; $I_{\rm SW}=-10~mA$	[3]	-	0.5	-	Ω
$C_{S(OFF)}$	OFF-state capacitance			-	4.5	-	pF
C <sub>S(ON)</sub>	ON-state capacitance			-	12	-	pF
SDAn, SO	CLn						
I <sub>S(OFF)</sub>	OFF-state leakage current		<u>[5]</u>	-	-	±1	μΑ
R <sub>ON</sub>	ON resistance	$V_{CC(A)} = 2 \text{ V}; \text{ V}_{I} = 0.4 \text{ V}; \text{ I}_{SW} = \pm 2 \text{ mA};$ See <u>Figure 5</u> and <u>Figure 7</u>		-	9	-	Ω
C <sub>S(ON)</sub>	ON-state capacitance			-	15	-	pF
R <sub>PU</sub>	pull-up resistance			-	4.7	-	kΩ
Control L	.ogic (SEL, EN)						
VIH	HIGH-level input voltage	$V_{CC(A)}$ = 2.3 V to 2.7 V		1.7	-		V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	-		V
		$V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V		$0.7V_{CC(A)}$	-		V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.8	V
		$V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V		-	-	$0.3V_{CC(A)}$	V
V <sub>H</sub>	hysteresis voltage			-	50	-	mV
I <sub>I</sub>	input leakage current	$V_{CC(A)} = 5.5 \text{ V}; \text{ V}_{I} = \text{GND to } V_{CC(A)}$		-	-	±1	μA

#### Table 8. Static characteristics ... continued

[1] All typical values are measured at  $V_{CC(B)}$  = 5 V,  $V_{CC(A)}$  = 3.3 V and  $T_{amb}$  = 25 °C unless otherwise specified.

[2] Measured at identical  $V_{CC}$ , temperature and input voltage.

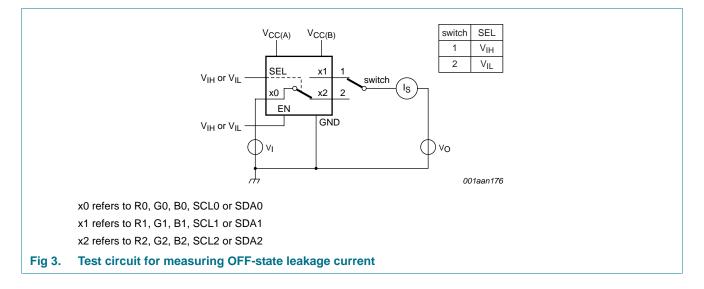
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and [3] temperature.

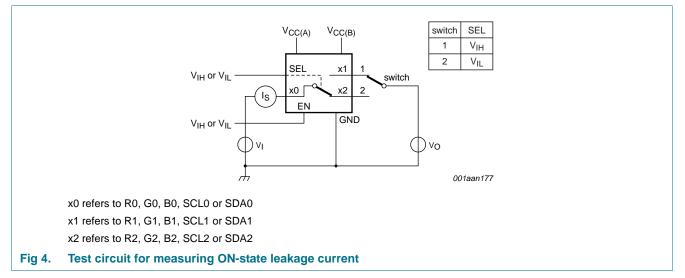
Guarantees the LOW level. [4]

[5] Guarantees the HIGH level.

Dual supply 1-of-2 VGA switch

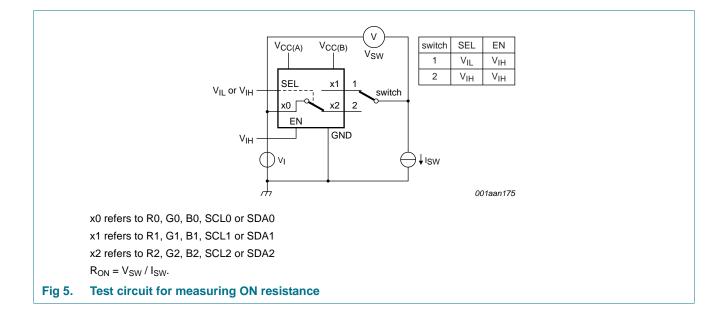
### 10.1 Test circuits and waveforms

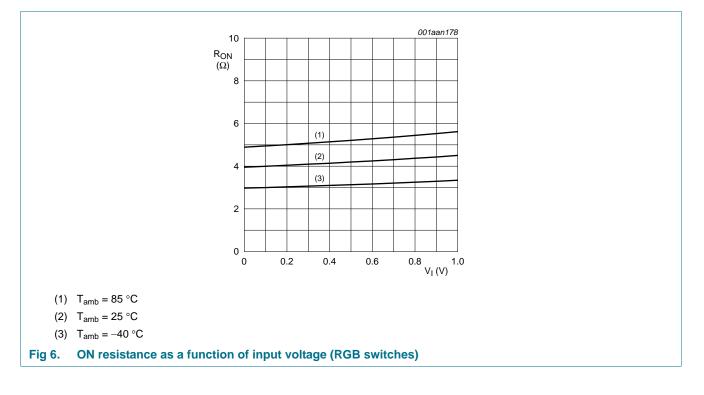






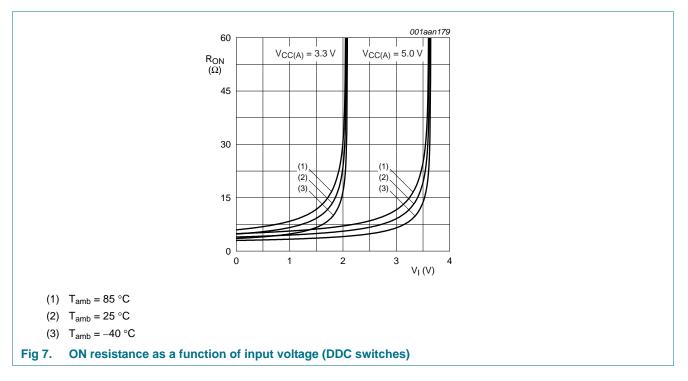
#### Dual supply 1-of-2 VGA switch





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#### Dual supply 1-of-2 VGA switch



### **11. Dynamic characteristics**

#### Table 9.Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V;  $V_{CC(B)}$  = 4.5 V to 5.5 V;  $V_{CC(A)}$  = 2 V to 5.5 V.

Symbol	Parameter	Conditions	Conditions		T <sub>amb</sub> = −40 °C to +85 °C		
				Min	Typ <mark>[1]</mark>	Max	
t <sub>pd</sub>	propagation delay	H0 to H1, H2 and V0 to V1, V2; See <u>Figure 8</u> and <u>Figure 9</u>	[2]	-	3	-	ns
t <sub>en</sub>	enable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	15	-	ns
t <sub>dis</sub>	disable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	5	-	ns
t <sub>b-m</sub>	break-before-make time	See Figure 12		-	10	-	ns
t <sub>sk(o)</sub>	output skew time	Skew between any Rn, Gn and Bn ports; see <u>Figure 8</u>	<u>[3]</u>	-	50	-	ps

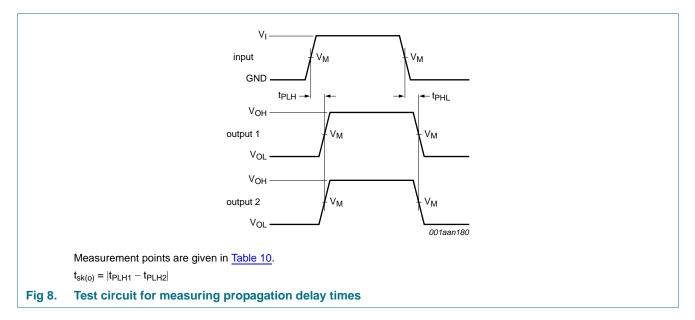
[1] All typical values are measured at V\_{CC(B)} = 5 V; V\_{CC(A)} = 3.3 V; T\_{amb} = 25 \ ^{\circ}C.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3] Guaranteed by design.

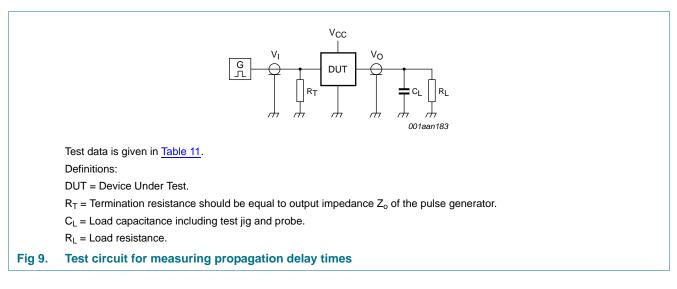
Dual supply 1-of-2 VGA switch





#### Table 10.Measurement points

Input		Output		
V <sub>M</sub>	VI	V <sub>X</sub>	V <sub>M</sub>	
0.5V <sub>CC(A)</sub>	GND to V <sub>CC(A)</sub>	0.9V <sub>OH</sub>	0.5V <sub>CC(B)</sub>	

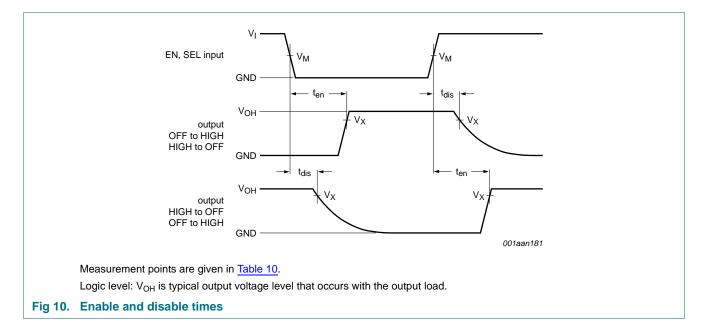


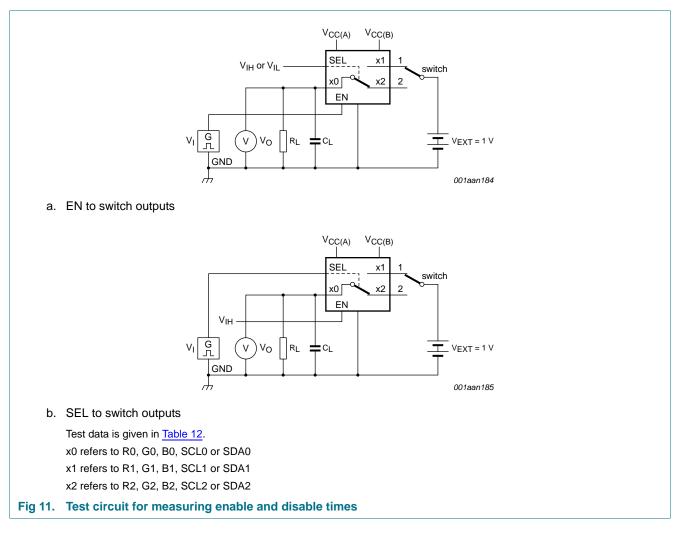
#### Table 11. Test data

Input	Load	
t <sub>r</sub> , t <sub>f</sub>	CL	RL
$\leq$ 2.5 ns	10 pF	1 kΩ

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### Dual supply 1-of-2 VGA switch

nput			Load		
r, t <sub>f</sub>	1	/ <sub>1</sub>	CL	RL	
≤ 2.5 ns	(	GND to V <sub>CC(A)</sub>	10 pF	100 Ω	
			VCC(A) VCC(B) SEL x1 x0 x2 EN RL CL	VEXT = 1 V 001aan182	
a. Test	circuit				
		V10.5	ÿVι		
		Vo	0.9Vo	0.9V <sub>0</sub>	
b. Inpu	t and output measu	rement points			
	data is given in <u>Table</u>				
x0 re	efers to R0, G0, B0, SC	L0 or SDA0			
	fers to R1, G1, B1, SC				
x2 re	fers to R2, G2, B2, SC	L2 or SDA2			
Fig 12. Test	circuit for measur	ing break-before-	make timing		

NX5DV715 Product data sheet

## 12. Additional dynamic characteristics

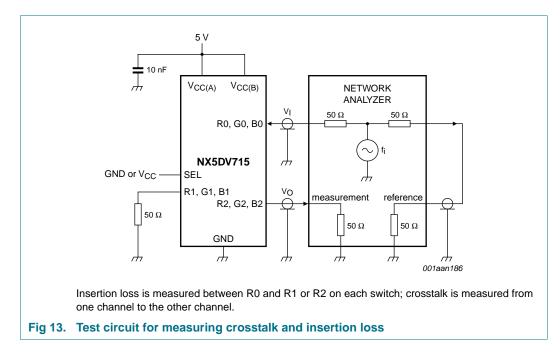
#### Table 13. Additional dynamic characteristics

 $V_{CC(B)}$  = 5.0 V ± 10 %,  $V_{CC(A)}$  = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		T <sub>amb</sub> = −40 °C to +85 °C			Unit
				Min	Тур	Max	
f <sub>(-3dB)</sub>	-3 dB frequency response	$R_L = 50 \Omega$ ; see Figure 13	[1]	-	600	-	MHz
$\alpha_{\text{ins}}$	Insertion loss	f <sub>i</sub> = 1 MHz; R <sub>L</sub> = R <sub>S</sub> = 50 Ω; see <u>Figure 13</u>		-	0.6	-	dB
Xtalk	crosstalk	between switches; $f_i = 50 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see <u>Figure 13</u>	[1]	-	-50	-	dB

[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

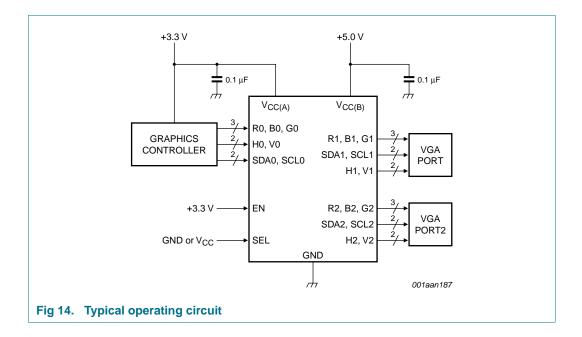
### 12.1 Test circuits



Dual supply 1-of-2 VGA switch

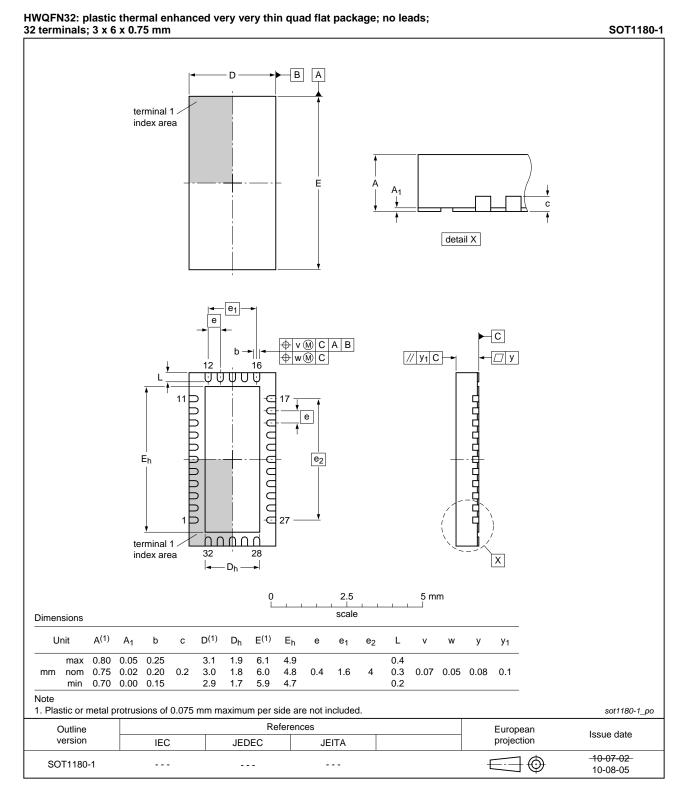
# **13. Application information**

The NX5DV715 provides the level shifting necessary to drive two standard VGA ports from a graphic controller as low as 2.2 V. Internal buffers drive the H-Sync and V-Sync signals to VGA standard TTL levels. The DDC multiplexer provides level shifting by clamping signals to a diode drop less than  $V_{CC(A)}$  (See Figure 14). Connect  $V_{CC(A)}$  to 3.3 V for normal operation, or to  $V_{CC(B)}$  to disable voltage clamping for DDC signals



Dual supply 1-of-2 VGA switch

### 14. Package outline



#### Fig 15. Package outline SOT1180-1 (HWQFN32)

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NX5DV715

Dual supply 1-of-2 VGA switch

## **15. Abbreviations**

Table 14.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DDC	Display Data Channel
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
RGB	Red Green Blue
TTL	Transistor-Transistor Logic
VESA	Video Electronics Standards Association

# 16. Revision history

Table 15.    Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV715 v.3	20111104	Product data sheet	-	NX5DV715 v.2
Modifications:	<ul> <li>Legal pages</li> </ul>	updated		
NX5DV715 v.2	20110725	Product data sheet	-	NX5DV715 v.1
NX5DV715 v.1	20101220	Product data sheet	-	-

## 17. Legal information

### 17.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### Dual supply 1-of-2 VGA switch

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### **18. Contact information**

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